

# **DATASHEET**

# **6 PIN DIP PHOTOTRANSISTOR PHOTOCOUPLER 4N2X Series 4N3X Series H11AX Series**





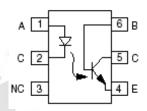


#### Features:

- 4N2X series: 4N25, 4N26, 4N27, 4N28
- 4N3X series: 4N35, 4N36, 4N37, 4N38
- H11AX series: H11A1, H11A2, H11A3, H11A4, H11A5
- High isolation voltage between input and output (Viso=5000 V rms)
- Creepage distance >7.62 mm
- Operating temperature up to +110°C
- Compact dual-in-line package
- Pb free and RoHS compliant.
- UL and cUL approved(No. E214129)
- VDE approved (No. 132249)
- NEMKO approval
- DEMKO approval
- FIMKO approval
- CQC approved

# SEMKO approved

#### **Schematic**



### Pin Configuration

- 1. Anode
- 2. Cathode
- 3. No Connection
- 4. Emitter
- 5. Collector
- 6. Base

## **Description**

The 4N2X, 4N3X, H11AX series of devices each consist of an infrared emitting diode optically coupled to a phototransistor.

They are packaged in a 6-pin DIP package and available in wide-lead spacing and SMD option.

### **Applications**

- Power supply regulators
- Digital logic inputs
- Microprocessor inputs



## Absolute Maximum Ratings (Ta=25)

	Parameter	Symbol	Rating	Unit
Input	Forward current	I <sub>F</sub>	60	mA
	Peak forward current (t = 10µs)	I <sub>FM</sub>	1	А
	Reverse voltage	$V_{R}$	6	V
	Power dissipation (T <sub>A</sub> = 25°C)	P <sub>D</sub> —	100	mW
	Derating factor (above 100°C)	FD	3.8	mW/°C
	Collector-Emitter voltage	$V_{\sf CEO}$	80	V
	Collector-Base voltage	$V_{CBO}$	80	V
Output	Emitter-Collector voltage	V <sub>ECO</sub> 7		V
	Emitter-Base voltage	V <sub>EBO</sub>	7	V
	Power dissipation (T <sub>A</sub> = 25°C)	D	150	mW
	Derating factor (above 100°C)	P <sub>C</sub> —	9.0	mW/°C
Total Power Dissipation		P <sub>TOT</sub> 200		mW
Isolation Voltage*1		V <sub>ISO</sub> 5000		V rms
Operating Temperature		T <sub>OPR</sub>	-55 to 110	°C
Storage Temperature		T <sub>STG</sub>	-55 to 125	°C
Soldering Temperature* <sup>2</sup>		T <sub>SOL</sub>	260	°C

## Notes:

<sup>\*1</sup> AC for 1 minute, R.H.=  $40 \sim 60\%$  R.H. In this test, pins 1, 2 & 3 are shorted together, and pins 4, 5 & 6 are shorted together.

<sup>\*2</sup> For 10 seconds



## Electro-Optical Characteristics (Ta=25 unless specified otherwise)

Input

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward voltage	$V_{F}$	-	1.2	1.5	V	I <sub>F</sub> = 10mA
Reverse current	$I_R$	-	-	10	μΑ	$V_R = 6V$
Input capacitance	$C_in$	-	30	-	pF	V = 0, f = 1MHz

Output

Parameter		Symbol	Min	Тур.	Max.	Unit	Condition
Collector-Base dark current		I <sub>CBO</sub>	-	-	20	nA	V <sub>CB</sub> = 10V
Collector- Emitter dark current	4N2X H11AX	- loso -	-	-	50	- nA	V <sub>CE</sub> = 10V, IF=0mA
	4N3X	– I <sub>CEO</sub>	-	-	50		V <sub>CE</sub> = 60V, IF=0mA
Collector-Emitter breakdown voltage		BV <sub>CEO</sub>	80	-	4.6	V	I <sub>c</sub> =1mA
Collector-Base breakdown voltage		$BV_CBO$	80	1		V	I <sub>C</sub> =0.1mA
Emitter-Collector breakdown voltage		BV <sub>ECO</sub>	7	4.		V	I <sub>E</sub> =0.1mA
Emitter-Base breakdown voltage		BV <sub>EBO</sub>	7		-	V	I <sub>E</sub> =0.1mA
Collector-Emitter capacitance		C <sub>CE</sub>		8	-	pF	VCE=0V, f=1MHz

<sup>\*</sup> Typical values at  $T_a = 25$ °C



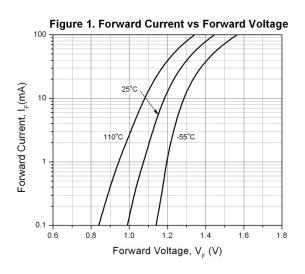
#### **Transfer Characteristics**

Par	ameter	Symbol	Min	Тур.	Max.	Unit	Condition	
	4N35, 4N36, 4N37	. CTR	100	-	-	- - - %		
Current Transfer ratio	H11A1		50	-	-			
	H11A5		30	-	-		$I_F = \pm 10$ mA , $V_{CE} = 10$ V	
	4N25, 4N26, 4N38, H11A2, H11A3		20	-	-			
	4N27, 4N28, H11A4		10	-	-			
Collector- Emitter saturation voltage	4N25, 4N26, 4N27, 4N28	V <sub>CE(sat)</sub>	-	-	0.5	- V	$I_F = 50 \text{mA}, I_c = 2 \text{mA}$	
	4N35, 4N36, 4N37		-	-	0.3		$I_F = 10 \text{mA}, I_c = 0.5 \text{mA}$	
	H11A1,H11A2, H11A3,H11A4, H11A5		-	-	0.4			
	4N38		-	-	1.0		$I_F = 20 \text{mA}, I_c = 4 \text{mA}$	
Isolation resistance		R <sub>IO</sub>	10 <sup>11</sup>	-	4	Ω	V <sub>IO</sub> = 500Vdc	
Input-output capacitance		$C_{IO}$	-	0.2	7-7	pF	$V_{IO} = 0$ , $f = 1MHz$	
Turn-on time	4N25, 4N26, 4N27, 4N28, H11A1,H11A2, H11A3,H11A4, H11A5	Ton	F	3	10	µs -	$V_{CC}$ = 10V, $I_F$ = 10mA, $R_L$ = 100 $\Omega$ See Fig. 11	
	4N35, 4N36, 4N37, 4N38			10	12		$V_{CC}$ = 10V, $I_C$ = 2mA, $R_L$ = 100 $\Omega$ , See Fig. 11	
Turn-off time	4N25, 4N26, 4N27, 4N28, H11A1,H11A2, H11A3,H11A4, H11A5	Toff	-	3	10	µs -	$V_{CC}$ = 10V, $I_F$ = 10mA, $R_L$ = 100 $\Omega$ See Fig. 11	
	4N35, 4N36, 4N37, 4N38		-	9	12		$V_{CC} = 10V$ , $I_C = 2mA$ , $R_L = 100\Omega$ , See Fig. 11	

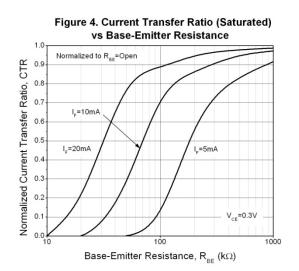
<sup>\*</sup> Typical values at  $T_a = 25$ °C



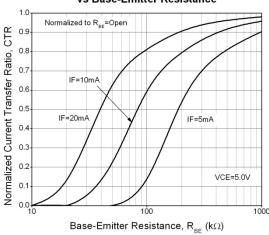
## **Typical Electro-Optical Characteristics Curves**



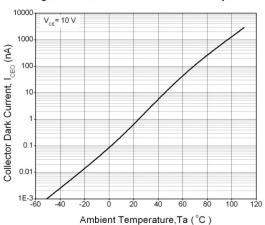
Forward Current, I<sub>F</sub> (mA)











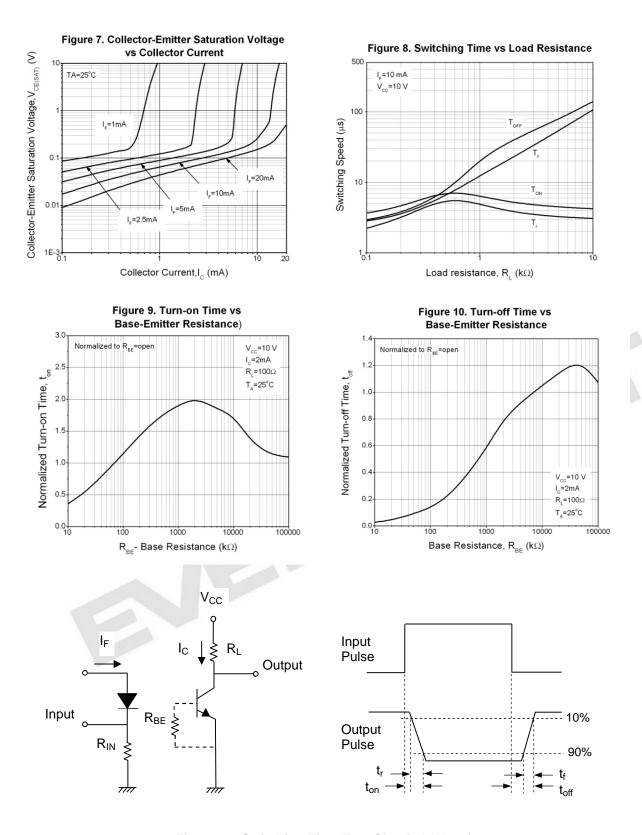


Figure 11. Switching Time Test Circuit & Waveforms



#### **Order Information**

**Part Number** 

4NXXY(Z)-V or H11AXY(Z)-V

#### Note

XX = Part no. for 4NXX series (25, 26, 27, 28, 35, 36, 37 or 38)

X = Part no. for H11AX series (1, 2, 3, 4, or 5)

Y = Lead form option (S, S1, M or none)

Z = Tape and reel option (TA, TB or none).

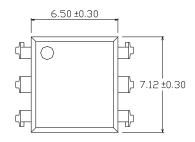
V = VDE safety (optional)

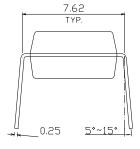
Option	Description	Packing quantity
None	Standard DIP-6	65 units per tube
М	Wide lead bend (0.4 inch spacing)	65 units per tube
S (TA)	Surface mount lead form + TA tape & reel option	1000 units per reel
S (TB)	Surface mount lead form + TB tape & reel option	1000 units per reel
S1 (TA)	Surface mount lead form (low profile) + TA tape & reel option	1000 units per reel
S1 (TB)	Surface mount lead form (low profile) + TB tape & reel option	1000 units per reel

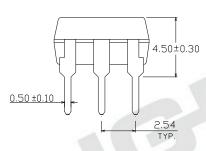


## Package Dimension (Dimensions in mm)

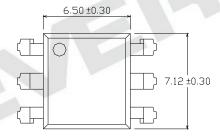
## **Standard DIP Type**

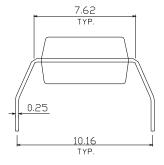


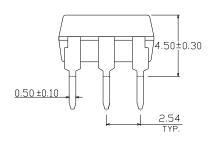




## **Option M Type**

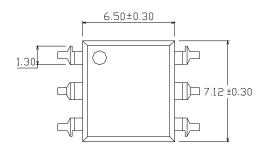


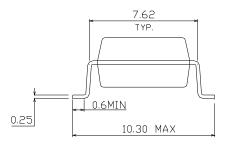


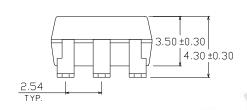




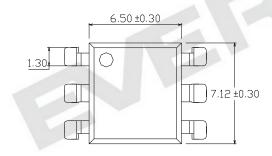
## **Option S Type**

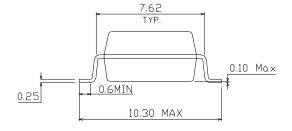


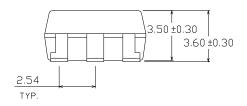




## **Option S1 Type**

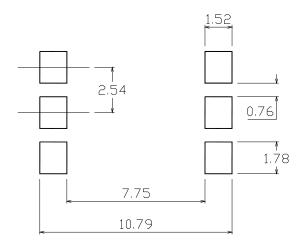




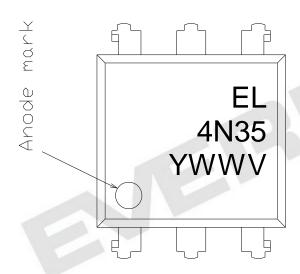




## Recommended pad layout for surface mount leadform



## **Device Marking**



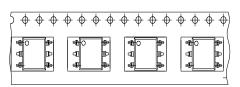
## **Notes**

EL denotes Everlight
4N35 denotes Device Number
Y denotes 1 digit Year code
WW denotes 2 digit Week code
V denotes VDE (optional)



## **Tape & Reel Packing Specifications**

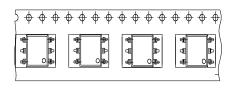
## **Option TA**





Direction of feed from reel

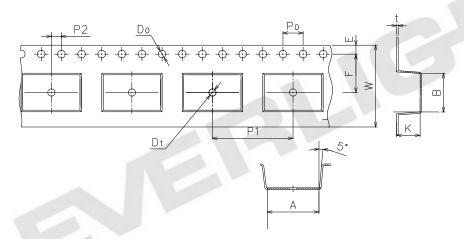
## **Option TB**





Direction of feed from reel

## **Tape dimensions**



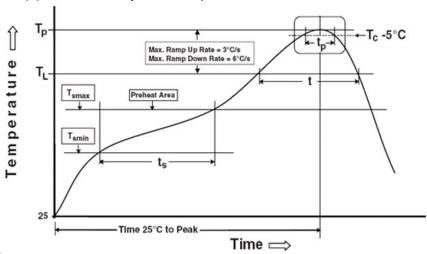
Dimension No.	Α	В	Do	D1	E	F
Dimension (mm)	10.4±0.1	7.5±0.1	1.5±0.1	1.5+0.1/-0	1.75±0.1	7.5±0.1
Dimension No.	Ро	P1	P2	t	w	К
Dimension (mm)	4.0±0.15	12±0.1	2.0±0.1	0.35±0.03	16.0±0.2	4.5±0.1



#### **Precautions for Use**

#### 1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note: Reference: IPC/JEDEC J-STD-020D

#### **Preheat**

Temperature min (T<sub>smin</sub>) 150 °C
Temperature max (T<sub>smax</sub>) 200 °C
Time (T<sub>smax</sub>) (200 °C

Time  $(T_{smin} \text{ to } T_{smax})$   $(t_s)$  60-120 seconds Average ramp-up rate  $(T_{smax} \text{ to } T_p)$  3 °C/second max

### Other

Liquidus Temperature (T<sub>L</sub>)

217 °C

Timo above Liquidus Temperature (t.)

Time above Liquidus Temperature (t <sub>L</sub>) 60-100 sec

Peak Temperature (T<sub>P</sub>) 260°C

Time within 5 °C of Actual Peak Temperature: T<sub>P</sub> - 5°C 30 s

Ramp- Down Rate from Peak Temperature 6°C /second max.

Time 25°C to peak temperature 8 minutes max.

Reflow times 3 times



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